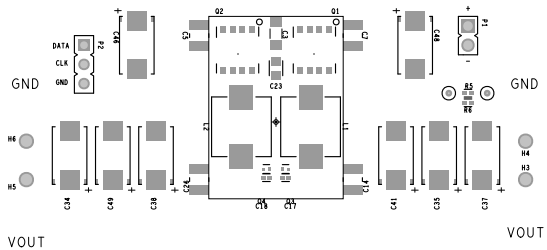




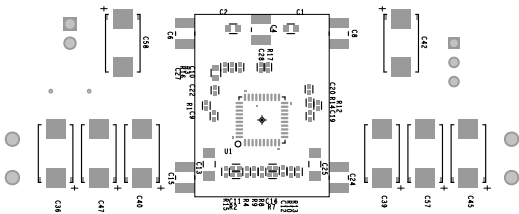
VIN ● H1 ● H2 GND

TEXAS INSTRUMENTS



PMP6924 REVA





R11  
C1  
C2

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